





# optris Infrared Cameras

### **Advanced thermal measurement systems**

Optris' infrared cameras are fully radiometric stationary thermographic systems with an excellent price-performance ratio. The thermal imaging cameras are connected to a PC via USB and Ethernet and they are immediately ready to be used. Temperature data is displayed through optris PIX Connect – the license-free analysis software.

### Non-contact temperature measurement made in Germany

Optris IR measurement devices enable constant monitoring and control of virtually every manufacturing process, and reductions in production costs through specific process optimization.

Once purchased, thermal imager are essential pieces of equipment used in a numerous industrial applications, e.g.

- Glass
- **Plastics**
- Metal
- Automotive
- Electric utility sector
- Fire prevention / Safety
- Maintenance
- Life Sience / Medical
- 3D printing & Additive manufacturing

For more infos on application examples see page 19.

### Applications Support

Optris application engineers and distribution partners have the experience and technical background necessary to apply its extensive portfolio of IR cameras and accessories to your temperature measurement challenge. Contact us directly or attend our numerous technical training events and YouTube presentations.



Further information on non-contact temperature measurement see our brochure:







# Have you seen our YouTube - Channel?

Learn more about Optris' infrared temperature measurement devices and their setup, properties and special features.

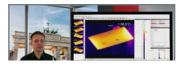
The Optris YouTube channel will give you an overview of our company and the world of infrared measurement technology.

Our videos will help you discover the functionality of our products and learn how to use them for your business:



- New products,
- How to's,
- Software tutorials
- **Hands-on-trainings**









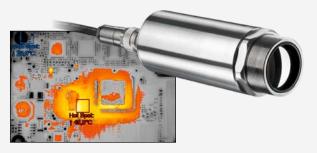
# The Compact and the Precision Line offer thermal imagers for all applications

## **Advantages Xi Compact Line**

- Compact affordable industrial imager for temperature measurements from –20 to 900 °C
- Motorized focus
- Autonomous operation (without PC) with automatic spot finder and direct analog output – ideal for OEM use (Xi 80 / 410)
- Direct Ethernet interface (Xi 80 / 410)

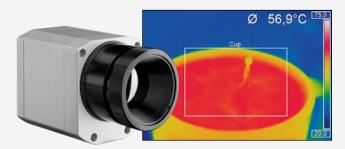
### **Advantages PI Precision Line**

- · Interchangeable lenses
- Suited for fast processes (up to 1 kHz)
- High thermal sensitivity (up to 40 mK NETD)
- High optical resolution (up to 764 x 480 Pixel)
- Laser blocking filters
- Temperature measuring ranges from –20 to 2450 °C
- Different spectral ranges
   (500 nm 800 nm / 1 μm / 7.9 μm / 8 14 μm)
- · Delivered with test certificate



### **Automatic hot spot search**

Objects can be thermally analyzed and hot or cold spots can be found automatically.

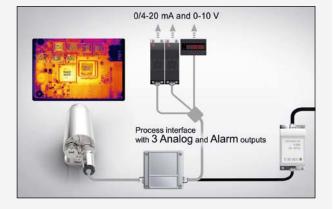


### **Fast measurements**

Temperature distributions on a surface can be precisely recorded at millisecond intervals.

# Autonomous operation with direct analog output

Up to 9 freely definable measuring areas may be used as analog outputs when using an external process interface.



### Simple process integration

Software Development Kit (SDK) for integration of the camera into customer-specific software via Dynamic Link Library (DLL) or COM-Port.

Interfaces to LabView and MATLAB are included as well.

### optris Microscope optics

The interchangeable and focusable microscope optics enable electrical testing and thermal analysis of smallest components at the same time - with an optical resolution of up to 28 µm. Fast processes



can easily be monitored with a frame rate of up to 125 Hz and, with the recording of radiometric video sequences and images, be saved for later analysis.

# optris PI series - Precision Line



# Infrared cameras PI series



Basic model		PI 400i / PI 450i						
Detector		FPA, uncooled (17 µm pitch)						
Optical resolution		382 x 288 pixels						
Spectral range		8–14 µm						
Temperature range	s	-20 100 °C 0 250 °C (20) 150 900 °C¹) 200 1500 °C (option)						
Frame rate		80 Hz / switchable to 27 Hz						
Optics (FOV) exchangeable		29° x 22° (f = 12.7 mm / F = 0.9) 18° x 14° (f = 20 mm / F = 1.1) 53° x 38° (f = 7.7 mm / F = 0.9) 80° x 54° (f = 5.7 mm / F = 0.9)						
Thermal sensitivity (NETD) <sup>2)</sup>		PI 400i: 75 mK with 29°, 53°, 80° FOV PI 400i: 100 mK with 18° FOV / F = 1.1 PI 450i: 40 mK with 29°, 53°, 80° FOV PI 450i: 60 mK with 18° FOV / F = 1.1						
System accuracy (a	at T <sub>Amb</sub> = 23 ±5 °C)	±2 °C or ±2 %, whichever is greater						
Temperature coeffic	cient	±0.05 % / K <sup>3)</sup>						
PC interfaces		USB 2.0 / optional USB to GigE (PoE) Interface						
Process interface (PIF)	Standard PIF	1x 0 – 10 V input, 1x digital input (max. 24 V), 1x 0 – 10 V output						
	Industrial PIF (optional)	2x 0 – 10 V input, 1x digital input (max. 24 V), 3x 0 / 4– 20 mA output, 3x relais (0 – 30 V / 400 mA), 1x fail-safe-relay						
Ambient temperatu	re (T <sub>Amb</sub> )	PI 400i: 0 50 °C / PI 450i: 0 70 °C						
Size		46 x 56 x 68 – 77 mm (depending on lens and focus position)						
Environmental ratir	ng	IP 67 (NEMA 4)						
Weight		237 - 251 g, depending on lens						
Power supply		via USB						
Power consumption	n (typical values)	1.5 W						
Scope of supply (st	andard)	USB camera with 1 lens USB cable (1 m) Table tripod PIF cable with terminal block (1 m) Manual Aluminum case (PI 400i) Rugged outdoor case (PI 450i)						

· Software package optris PIX Connect









PI 640i Microscope optics	PI 450i G7	PI 640i G7
FPA, uncooled (17 µm pitch)	FPA, uncooled (17 μm pitch)	FPA, uncooled (17 µm pitch)
640 x 480 pixels @ 32 Hz 640 x 120 pixels @ 125 Hz	382 x 288 pixels	640 x 480 pixels
8–14 µm	7.9 µm	7.9 µm
-20 100 °C 0 250 °C (20) 150 900 °C <sup>1)</sup> 200 1500 °C (option)	150 900 °C 200 1500 °C	150 900 °C 200 1500 °C
32 Hz / 125 Hz in subframe mode (640 x 120 pixels)	80 Hz / switchable to 27 Hz	32 Hz / 125 Hz in subframe mode (640 x 120 pixels)
12° x 9° ( f = 44 mm / F = 1.1 ) Smallest measuring spot (IFOV): 28 μm	29° x 22° (f = 12.7 mm / F = 0.9) 18° x 14° (f = 20 mm / F = 1.1) 53° x 38° (f = 7.7 mm / F = 0.9) 80° x 54° (f = 5.7 mm / F = 0.9)	33° x25°/f=18.7 mm / F = 0.8) 15° x11°/f=41.5 mm / F = 1.0) 60° x45°/f=10.5 mm / F = 0.8) 90° x64°/f=7.7 mm / F = 0.8)
80 mK	150 mK 175 mK (with 18 ° FOV)	80 mK with 33°, 60°, 90° FOV 120 mK with 15° FOV
±2 °C or ±2 %, whichever is greater	±2 °C or ±2 %, whichever is greater	±2 °C or ±2 %, whichever is greater
±0.05 % / K <sup>3)</sup>	-	-
USB 2.0 / optional USB to GigE (PoE) Interface	USB 2.0 / optional USB to GigE (PoE) Interface	USB 2.0 / optional USB to GigE (PoE) Interface
1x 0 – 10 V input, 1x digital input (max. 24 V), 1x 0 – 10 V output	1x 0 – 10 V input, 1x digital input (max. 24 V), 1x 0 – 10 V output	1x 0 – 10 V input, 1x digital input (max. 24 V), 1x 0 – 10 V output
2x 0 – 10 V input, 1x digital input (max. 24 V), 3x 0 / 4– 20 mA output, 3x relais (0 – 30 V / 400 mA), 1x fail-safe-relay	2x 0 – 10 V input, 1x digital input (max. 24 V), 3x 0 / 4– 20 mA output, 3x relais (0 – 30 V / 400 mA), 1x fail-safe-relay	2x 0 – 10 V input, 1x digital input (max. 24 V), 3x 0 / 4– 20 mA output, 3x relais (0 – 30 V / 400 mA), 1x fail-safe-relay
0 50 °C	0 70 °C	0 50°C
46 x 56 x 119 - 126 mm (depending on lens and focus position)	46 x 56 x 68 – 77 mm (depending on lens and focus position)	46 x 56 x 76 – 100 mm (depending on lens and focus position)
IP 67 (NEMA 4)	IP 67 (NEMA 4)	IP 67 (NEMA 4)
370 g, depending on lens	237 - 251 g, depending on lens	269 - 340 g, depending on lens
via USB	via USB	via USB
1.5 W	2.5 W	2.5 W
USB camera with lens kit (standard lens [PI 640i: O33], microscope lens [MO44]) Microscope stand Standard USB cable (1 m) Standard-PIF Manual Rugged outdoor case Software package optris PIX Connect	USB camera with 1 lens USB cable (1 m) Table tripod PIF cable with terminal block (1 m) Manual Rugged outdoor case Software package optris PIX Connect	USB camera with 1 lens USB cable (1 m) Table tripod PIF cable with terminal block (1 m) Manual Rugged outdoor case Software package optris PIX Connect
	FPA, uncooled (17 µm pitch)  640 x 480 pixels @ 32 Hz 640 x 120 pixels @ 125 Hz  8-14 µm  -20 100 °C 0 250 °C  (20) 150 900 °C¹) 200 1500 °C (option)  32 Hz / 125 Hz in subframe mode  (640 x 120 pixels)  12° x 9° (f = 44 mm / F = 1.1)  Smallest measuring spot (IFOV): 28 µm  80 mK  ±2 °C or ±2 %, whichever is greater  ±0.05 % / K³)  USB 2.0 / optional USB to GigE (PoE) Interface  1x 0 - 10 V input, 1x digital input (max. 24 V), 1x 0 - 10 V output  2x 0 - 10 V input, 1x digital input (max. 24 V), 3x 0 / 4 - 20 mA output, 3x relais (0 - 30 V / 400 mA), 1x fail-safe-relay  0 50 °C  46 x 56 x 119 - 126 mm  (depending on lens and focus position)  IP 67 (NEMA 4)  370 g, depending on lens  via USB  1.5 W  • USB camera with lens kit (standard lens [PI 640i: O33], microscope lens [MO44])  • Microscope stand • Standard-PIF • Manual • Rugged outdoor case	FPA, uncooled (17 μm pitch)  640 x 480 pixels @ 32 Hz 640 x 120 pixels @ 125 Hz  8-14 μm  -20 100 °C 0 250 °C 2001500 °C 20015

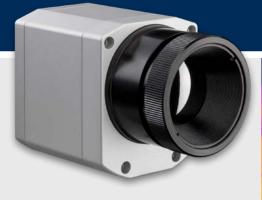
<sup>1)</sup> Accuracy effective starting at 150 °C
2) LT: Measurement of the noise equivalent temperature difference (NETD) according to VDI 5585 standard, method B; 25 °C black body temperature (-20-100 °C range), frame rate 20 Hz averaged

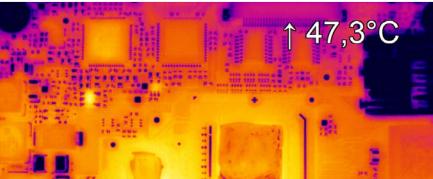
# optris PI 640i

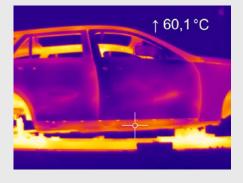
### THERMOGRAPHY IN VGA RESOLUTION

# One of the most compact infrared cameras in the world

- 640 x 480 pixels
- Radiometric video recording at 32 Hz / 125 Hz in subframe-mode (640 x 120 pixels)
- Compact size of 46 x 56 x 76 100 mm (depending on lens)
- Lightweight (269 340 g, depending on lens)
- · Includes license-free analysis software and full SDK





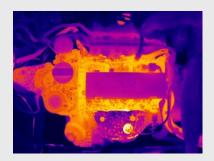


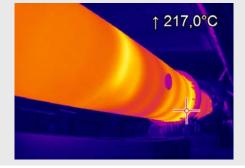
# Razor sharp infrared pictures and videos for process optimization

With a casing size of only 46 x 56 x 90 mm and a weight of 320 grams (depending on lens), the optris PI 640i is among the most compact infrared cameras on the market.

The high-definition optris PI 640i infrared camera is best used in applications where finest thermal details matter.

It significantly contributes to process optimization in both research and development and in industry.







## optris PI 05M / PI 08M / PI 1M

### INFRARED CAMERAS FOR THE SHORTWAVE DOMAIN

# Ultra-compact infrared cameras for the metal industry

- Highly dynamic CMOS detector with an optical resolution of up to 764 x 480 pixels
- Very large temperature measurement ranges (without sub-ranges) of 450 °C to 1800 °C (PI 1M), 575 °C to 1900 °C (PI 08M) and of 900 °C to 2450 °C (PI 05M)
- Frame rates and line scanning function up to 1 kHz for fast processes
- Real-time output of 8x8 pixels with 1 ms response time
- · Includes license-free analysis software and full SDK
- New: PI 08M Ideally suited for all laser processing applications with solid-state lasers in NIR through excellent blocking of radiation



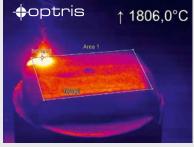
# Smart temperature measurement – Innovative and fast

The IR cameras optris PI 05M, PI 08M and PI 1M are specially suited for measuring the temperature of metals, as these exhibit a distinctly higher emissivity at the short measurement wavelength of 500 nm and 1  $\mu$ m than at measurements in the previously conventional wavelength range of 8 – 14  $\mu$ m.

Especially the spectral range of 500 nm enables for more precise measurements at changing emissivities and is less sensitive to atmospheric influences. Thus, the PI 05M is ideally suited for temperature measurements of molten metals.

A direct 1 ms analog output allows all camera models a readout of a freely selectable 8x8 pixel region in real-time. The use of these image sensors allows a large dynamic range for temperature measurement so that the previously necessary use of relatively many and narrowly defined sub-ranges is no longer required. The PI 1M, PI 08M and PI 05M's two-dimensional temperature measurement opens up new options compared to the usual spot measurement of pyrometers.

Thanks to the large measurement temperature range of 450 °C up to 2450 °C, the optris PI 05M, PI 08M and PI 1M IR camera satisfies practically all demands in the fields of metal production and processing.

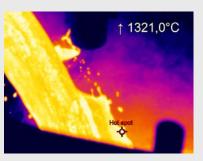


Measurement during laser welding process

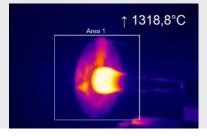


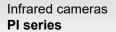
Induction heating





Measurement of a pouring stream











Basic m	odel	PI 05M		PI 08M		PI 1M			
Detector		CMOS (15 µm pitch)		CMOS (15 µm pitch)		CMOS (15 µm pitch)			
Optical resolu	ition	72 x 56 pixels @ 1 kl	Hz (switchable to 27 Hz)	72 x 56 pixels @ 1 k	Hz (switchable to 27 Hz)	764 x 480 pixels @ 32 Hz 382 x 288 pixels @ 80 Hz (switchable to 27 Hz) 72 x 56 pixels @ 1 kHz 764 x 8 pixels @ 1 kHz (fast line scan mode)			
Spectral range	e	500 – 540 nm		780 – 820 nm		0.85 – 1.1 μm			
Temperature range		900 2450 °C (27 H 950 2450 °C (32 / 1100 2450 °C (1 kH	80 Hz modes)	575 1900 °C (27 F 625 1900 °C (32 / 750 1900 °C (1 kF	80 Hz mode)	450 <sup>1)</sup> 1800 °C (27 H 500 <sup>1)</sup> 1800 °C (80 / 600 <sup>1)</sup> 1800 °C (1 kH	32 Hz mode)		
Frame rate		Up to 1 kHz / 1 ms rea (0 - 10 V) of 8 x 8 pixe		Up to 1 kHz / 1 ms rea (0 - 10 V) of 8 x 8 pixe		Up to 1 kHz / 1 ms rea (0 - 10 V) of 8 x 8 pixe			
Optics (FOV) exchangeable		FOV@764 x 480 px: 26° x 16° (f=25 mm)	FOV@382 x 288 px: 13° x 10° (f = 25 mm)	FOV @ 764 x 480 px: 26° x 16° (f = 25 mm) 39° x 25° (f = 16 mm)	FOV@382 x 288 px: 13° x 10° (f= 25 mm) 20° x 15° (f= 16 mm)	FOV@764 x 480 px: 39° x 25° (f = 16 mm) 26° x 16° (f = 25 mm) 13° x 8° (f = 50 mm) 9° x 5° (f = 75 mm)	FOV@382 x 288 px: 20° x 15° (f = 16 mm) 13° x 10° (f = 25 mm) 7° x 5° (f = 50 mm) 4° x 3° (f = 75 mm)		
F-number	number 1.4					1.4 ( 39° and 26° lens 2.4 ( 13° lens) 2.8 ( 9° lens)	;)		
Thermal sens	itivity NETD <sup>2)</sup>	< 2 K (< 1400 °C) < 4 K (< 2100 °C)		< 2 K (< 1000 °C) < 4 K (< 1600 °C)		< 2 K (< 900 °C) < 4 K (< 1400 °C)			
System accuracy (at T <sub>Amb</sub> = 23 ±5 °C)		For object temperature ±1 % of reading for 27/2 ±1.5 % of reading for 1 For object temperature ±2 % of reading for 27/2 ±2.5 % of reading for 1	32/80 Hz kHz > 2000 °C: 32/80 Hz	For object temperature ±1 % of reading for 27. ±1.5 % of reading for 1 For object temperature ±2 % of reading for 27. ±2.5 % of reading for 1	/32/80 Hz   kHz  > 1500 °C: /32/80 Hz	For object temperature < 1400 °C: ±1 % of reading for 27/32/80 Hz ±1.5 % of reading for 1 kHz For object temperature < 1600 °C: ±2 % of reading for 27/32/80 Hz ±2.5 % of reading for 1 kHz			
PC interfaces		USB 2.0 / optional US interface	B to GigE (PoE)	USB 2.0 / optional US interface	SB to GigE (PoE)	USB 2.0 / optional USB to GigE (PoE) interface			
Process Interface	Standard PIF	1x 0 - 10 V input, 1x (max. 24 V), 1x 0 - 1		1x 0 - 10 V input, 1x (max. 24 V), 1x 0 - 1		1x 0 – 10 V input, 1x digital input (max. 24 V), 1x 0 – 10 V output			
(PIF)	Industrial PIF (optional)	2x 0 – 10 V inputs, 1x 3x 0 / 4-20 mA output 400 mA), 1x fail-safe			digital input (max. 24 V), ts, 3x relais (0 – 30 V / relay	2x 0 – 10 V inputs, 1x digital input (max. 24 V), 3x 0 / 4-20 mA outputs, 3x relais (0 – 30 V / 400 mA), 1x fail-safe relay			
Ambient temp	erature (T <sub>Amb</sub> )	550 °C		5 50 °C		550 °C			
Size		46 x 56 x 88 – 129 m (depending on lens an		46 x 56 x 88 – 129 n (depending on lens at	nm with protection tube nd focus position)	46 x 56 x 88 – 129 m (depending on lens ar	nm with protection tube nd focus position)		
Environmenta	l rating	IP 67 (NEMA 4)		IP 67 (NEMA 4)		IP 67 (NEMA 4)			
Weight		245 - 311 g, dependir	ng on lens	245 - 311 g, dependi	ng on lens	245 - 311 g, dependi	ng on lens		
Power supply		via USB		via USB		via USB			
Power consur (typical values	•	2.5 W		2.5 W		2.5 W			
(typical values)  Scope of supply (standard)		USB camera with 1 Lens tube incl. prot USB cable (1 m) Table tripod PIF cable with term Software package of Manual Aluminum case Optional: CoolingJa	ective window inal block (1 m) optris PIX Connect	USB camera with 1 Lens tube incl. pro USB cable (1 m) Table tripod PIF cable with tern Software package Manual Aluminum case Optional: CoolingJ	tective window ninal block (1 m) optris PIX Connect	USB camera with 1 lens Lens tube incl. protective window USB cable (1 m) Table tripod PIF cable with terminal block (1 m) Software package optris PIX Connect Manual Aluminum case Optional: CoolingJacket, HT cable			

### **Accessories PI series**

### Outdoor protective housing for infrared cameras

#### part number: ACPIOPH

#### **Features**

- Environmental rating IP 66
- Additional air purge collar allows for a continuous operation in dusty and humid conditions
- Heating element and built-in fan enable for a 24/7 operation from -40 °C to 50 °C
- Installation of USB Server Gigabit 2.0 and industrial process interface possible for integration into control systems over largeoutdoor distances



#### part number: OPTPINBW732G

#### **Features**

- Miniature PC as an add-on to the PI series for stand-alone system or for cable extension via GiqE
- · Integrated hardware and software watchdog
- · Installation of additional user software possible
- · Status LEDs
- Processor: Intel® E3845 Quad Core / 1.91 GHz, 16 GB SSD, 2 GB RAM
- Connections: 2x USB 2.0, 1x USB 3.0, 1x Mini USB 2.0, Micro HDMI, Ethernet (Gigabit Ethernet), Micro SDHC / SDXC card
- Wide supply voltage range (8 48 V DC) or Power over Ethernet (PoE)
- · Can be integrated into CoolingJacket Advanced





### USB Server Gigabit 2.0 for optris PI cameras

### part number: ACPIUSBSGB

#### **Features**

- Fully USB 2.0 compatible, Data rates: 1.5 / 12 / 480 mbps, USB transfer mode: Isochronous
- · Network connection via Gigabit Ethernet
- For optris PI series and Xi 400 as well as CTvideo / CSvideo series
- · Full TCP/IP support incl. routing and DNS
- · Two independent USB ports
- Supply from PoE or external power supply with 24 48 V DC
- Galvanic isolation 500 V<sub>RMS</sub> (network connection)
- · Remotely configurable via Web Based Management

### Industrial Process Interface (PIF) for optris PI series

#### part number: ACPIPIFMA

#### Features

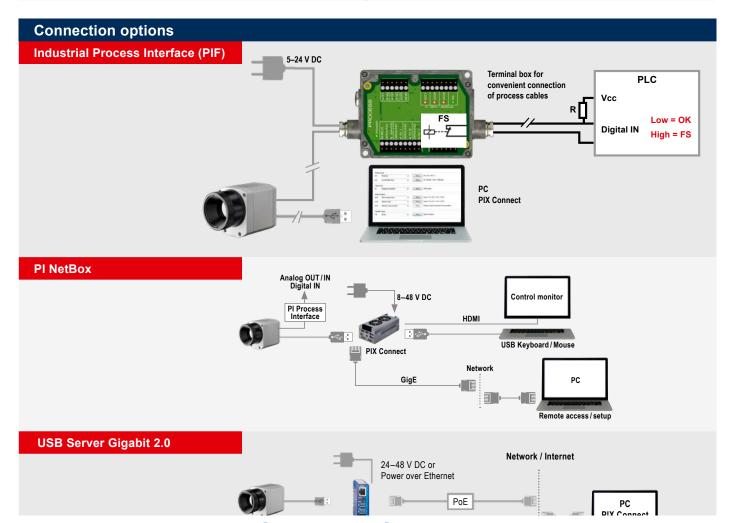
- Industrial process interface for PI series with 3 analog / alarm outputs, 2 analog inputs, 1 digital input, 3 alarm relais
- 500 V  $AC_{\rm RMS}$  isolation voltage between camera and process
- · Separate fail-safe relay output
- PI hardware including all cable connections and PIX Connect software are permanently observed during operation





## **Accessories PI series**

### **CoolingJacket Advanced** Laminar air purge part number: ACCJAAPLS part number: ACPICJA **Features Features** · Operation at ambient temperatures up to 315 °C · Protection for rugged environments · Air/ water cooling with integrated air purging and optional protective windows · Air and water cooling, flexible laminar air stream for protection from dirt and dust · Modular concept for easy installation of different devices and optics · Easy maintenance due to folding mechanism · Trouble-free sensor disassembling on site with quick release chassis · Focussable from the outside once installed • Integration of additional components like PI NetBox, USB Server Gigabit 2.0 · Protection window for mechanical protection integrated and Industrial Process Interface (PIF) in extended version · Also available as line scanner version



### Application examples for non-contact temperature measurement

The process and product temperature is an important physical indicator for manufacturing processes and ensures a high quality level of the production line.

All Optris products apply in different areas, covering the non-contact temperature measurement. This covers the automotive industry, the food industry as well as 3D printing & additive manufacturing.

#### Electronics industry Plastics industry Fire prevention Metal industry Component inspection Injection molding Infrared technology Workpiece control of circuit boards in waste processing during drop forging More and more manufacturers In order to prevent component Early fire detection with infrared In drop forging, the semi-finished distortion during injection molding, products must be at a certain of electronic circuit boards rely cameras is an important protective the process is monitored by thermal measure in industry to prevent forging temperature before forming. on noncontact temperature measurement due to the constantly imaging cameras detecting and irreparable damage to industrial In order to achieve the optimum increasing performance of their adjusting temperature over- or plants and buildings. production result, the surface undershoots during molded part temperature of the material is components. measurement. controlled accordingly. Recommended devices: Recommended device: Recommended device: Recommended devices: PI 450i Xi 400 PI 1M. PI 640i Microscope optics, PI 05M Xi 400 Microscope optics

References: 1) GTT Willi Steinko

Further information see our application brochures:



Metal







**Glass** 

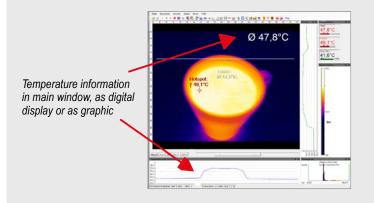
Industries	Application notes
Fire prevention / Safety	Battery monitoring with IR temperature measurement
	Early fire detection with infrared cameras
	Infrared cameras monitor planing systems - from fire protection to quality control

# optris PIX Connect Software

**FEATURES** 

# Comprehensive IR camera software

- · No additional costs or licensing restrictions
- · Modern software with intuitive user interface
- · Remote control of camera
- · Display of numerous images in different windows
- · Compatible with Windows 7, 8, 10 and 11
- Two Software Development Kits for Windows and Linux included
- · Various language options, incl. translation function
- · Temperature display in °C or in °F



Our layouts – as individual as your applications

Pre-defined layouts make it quick and easy to start with your applications. And because we know that every measurement task has its own individual requirements, we have ensured that it is quite easy to adapt the preset layout to suit your individual requirements.

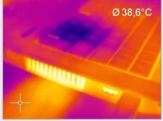
The user interface of the PIX Connect software can also be adapted to suit your personal workflow: Software windows can be easily arranged using drag & drop; in the toolbar you can save shortcuts for functions relevant to your application – or even remove links which you do not need.

Regardless of whether you are working on a desktop PC or a tablet, the user interface can be adapted.

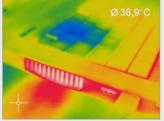
The PIX Connect software makes a wide range of preset color palettes available. This allows optimal depiction of thermal contrasts. The pre-defined color palettes can be individually adapted to be able to cater for the specific requirements of your respective application.

Associated temperature groups (isotherms) can be identified by color markers and highlighted.

It is also possible to define temperature values in advance; pixels above, below, or between these values are highlighted in color.



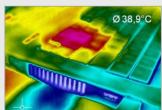


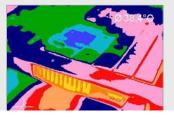


Palette Rainbow

# The right color palette for every application

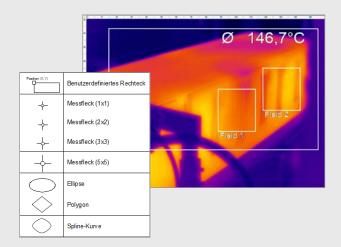








# It is not just a matter of size, but also depends on the content: designing a suitable measurement area



The size and shape of measurement area can be freely designed and moved. For an easy introduction, a large selection of pre-defined measurement area shapes is available.

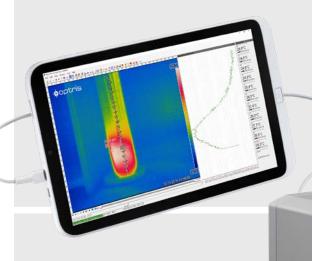
You can set up as many measurement areas as you like in the camera's field of view. To do this, it is possible to make a distinction between main and ancillary fields.

Various modes can be set in a measurement area, such as minimum value, maximum value, or average value, or you can rule out the detection of hot or cold spots.

The separate setting of the emissivity for measurement areas allows various material surfaces to be monitored with a single camera.

Differences and averaging between different measurement areas are easy to calculate with the PIX Connect software.

Saved measurement areas can be displayed as an image, a digital display or a diagram and can then be saved for further analysis.

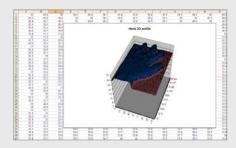


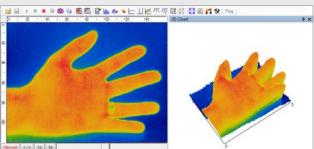
# Graphic display of the temperature values

Temperature values can be shown along a straight line as temperature profiles as well as as 3D diagrams.

A temperature/time diagram can be used to analyze the temperature development over time. Individual time sections can be lifted out of the diagram and be analyzed in detail by zooming in and out.

Diagrams defined in this way can be exported from the software and be saved in Excel for further analysis.



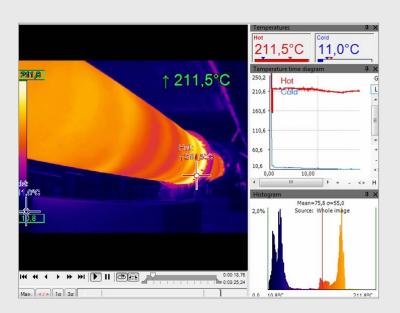


# optris PIX Connect Software

**FEATURES** 

### Recording and display

# Recording video sequences – for later analysis and documentation



Beside of single snapshots also video recordings can be made with the software, both with radiometric data included. This allows a detailed analysis of the measurement results afterwards.

An integrated screen capture function makes it simple to retrospectively generate videos in wmv format.

Videos recorded can be processed retrospectively. For example, individual sections can be cut out of a recording and can be saved as an independent sequence.

Saved video recordings are available for analysis. The sequences can be played back in slow motion or time lapse for this purpose. It is also possible to play back as a continuous loop.

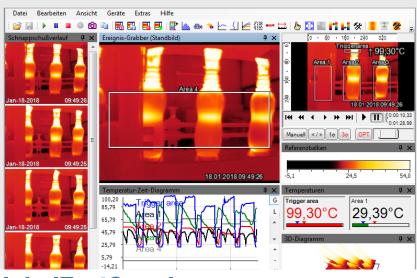
### **Event grabber**

The snapshot option works like a screenshot; an individual image is recorded from the live picture. This snapshot is a radiometric image (\*.tiff), where all the temperature and measurement area information at the time of the recording is saved for every pixel.

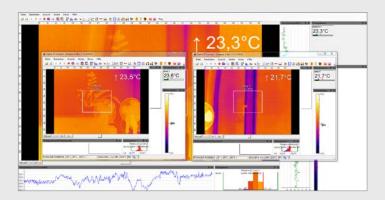
Saving and exporting the image for further analysis in Excel is possible thanks to the option of saving the temperature matrix in text format, e.g. as comma-separated values (.csv format). It is also possible to continue processing the image data with standard programs such as Photoshop or Windows Media Player.

Sections of the saved image can be zoomed in to get a closer look 3D display is also possible

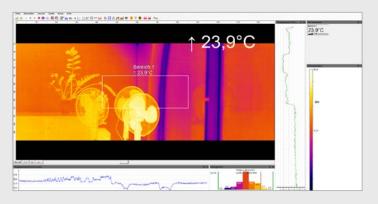
# Snapshots – all temperature information in one picture



### Merging



The fields of vision of three cameras (top) are converted into one single image via the merging function. (bottom)



# The merging function combines several camera angles together in a single picture

The PIX Connect software gives you the option of grouping together several cameras within a software instance, i.e. the field of view of several infrared cameras are merged together to make a single picture. For processes with several control points in particular, it is helpful to concentrate the various angles on one screen. Merging several cameras also makes it possible to get an all-round view of a 3D object.

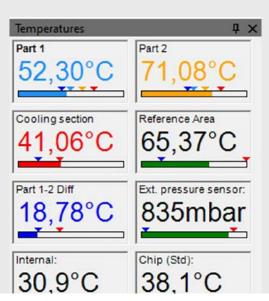
You can merge several cameras either using a direct USB connection or via Ethernet. While in the first case, every camera needs to have its own USB port; for the second option, one Ethernet connection is enough. The cameras here are each connected to the Ethernet switch on the PC via a USB Server Gigabit 2.0.

### **Alarms**

# Defining several alarm values – allows quick intervention

Alarms for freely definable measurement areas, calculated objects, uncommitted values of external transmitters as well as the internal temperature of the camera can be chosen via the software. Apart from minimum and maximum values, it is also possible to set so-called advance alarms. These will emit a warning when the measured temperature approaches the defined minimum or maximum value, therefore giving you more options and time to react.

If the measured temperature reaches one of the previously defined values, then the software will trigger an alarm which can be forwarded to a PLC via the process interface. In addition to that, the critical event can be



# optris PIX Connect Software

### **FEATURES**

# For the measurement of moving objects

The optris PIX Connect software is equipped with a line scan camera function.

The line scanner is primarily used for processes involving moving measurement objects, like rotary kiln measurements or large quantities on conveyor belts (batch process).



Application example: rotary kiln in the chemical industry

initialize the function

Activation of the line scan camera

function (continuous, self-triggered, external trigger) and definition of the position of the lines in the thermal

image. For this the camera itself serves

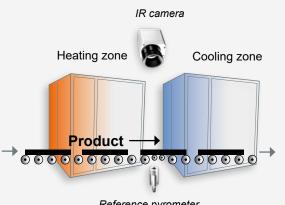
Only 3 steps to

as an orientation aid.

Step 1

### The advantages

Simple monitoring of processes with limited visual access



Indirect visualization of heat distribution in ovens via camera installation at oven exit

Increase the number of pixels, e.g. from 640 pixels to 800 pixels by diagonal screen measurement

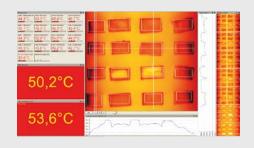
Reference pyrometer

# Step 2

Configuration of line scan function, e.g. number of lines displayed or set trigger for automatic saving of images.

#### Step 3

Definition of individual layouts, e.g. display of saved images in the snapshot process.



Layout example for display of line scan camera function

# Lines have FOV of up to 111° for detailed process analysis, e.g. on wide conveyer belts

Any number of lines 800 pixels

Up to 32 Hz data recording\* of unlimited lines which in turn produce a thermal image of any given resolution.

For more software tutorials watch our



optris Top Down GIS 640 R

# **Glass inspection system** for process control in glass tempering machines



With the new glass inspection system, temperature differences during glass hardening processes can be quickly detected, thus avoiding rejects and providing automatic quality monitoring.

The Top Down GIS 640 R system with temperature referencing by means of a sensor from below as well as automatic emissivity correction for standard and low-E glasses was specially developed for process control in glass tempering machines.



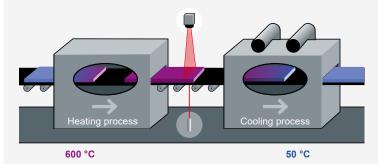
### **PIX Connect Software**

### Measurement principle

A variety of optics with different field of views allows an optimal mounting of the camera at a larger distance (no cooling needed) and avoids influences by the angle dependent emissivity.

Positioning of IR camera and reference pyrometer in a Top Down Glass Inspection System.







Comprehensive IR camera software without licensing restrictions and with intuitive user interface.



Monitoring temperatures of glass sheets

### Important specifications

- · Top down system with additional reference pyrometer from underneath for automatic emissivity correction
- Digitally controlled lens protection system (DCLP) avoids extra air purging
- · Glass area calculation
- · Pre-assembled system for easy installation on glasstempering furnaces

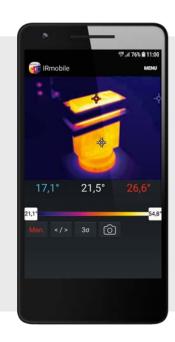
## Tool for all optris infrared cameras





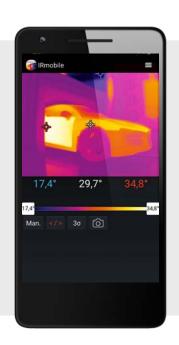
- The cameras of the PI series have a direct connection to an android smartphone or tablet
- IRmobile App downloadable for free from the Google Play Store
- For connection to the device the IR App Connector is recommended

Xi 80 / 410 Part number: ACXI80IACM (Micro-USB) or ACXI80IACC (USB-C) Xi 400 Part number: ACPIIACM (Micro-USB) or ACPIIACC (USB-C)



### IRmobile app features:

- Live IR image with automatic hot and cold spot search
- Taking snapshots and analyze them later with PIX Connect software
- Adjustable camera features like temperature measuring range, frame rate and selectable color palettes
- Changing the temperature unit: Celsius or Fahrenheit
- Integrated simulator



### Supported for

- PI and Xi series and all pyrometers
- For android devices from version 5.0 or higher with micro-USB or USB-C connectors that support USB OTG







# optris Calculator

APP

# Precise measuring at various distances

A choice of lenses allows you to precisely measure objects at various distances, from close and standard distances right up to large distances. The IR cameras of the optris PI series allow for changing between several lenses.

With infrared cameras there are various parameters which display the relationship between the distance from the measuring object and the size of the pixel on the object plane. In choosing the correct lens, the following should be taken into account:

**HFOV** Horizontal expansion of the total measuring field on the object plane

**VFOV** Vertical expansion of the total measuring field on the object plane

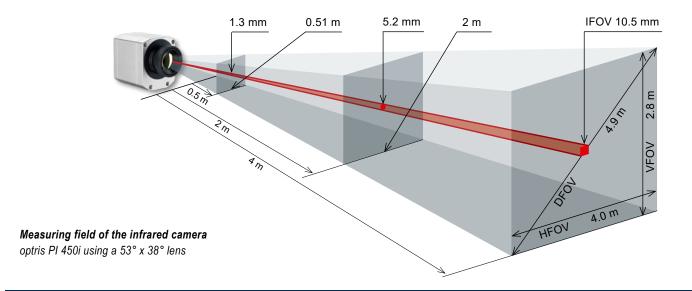
**IFOV** Size of individual pixels on the object plane

**DFOV** Diagonal expansion of the total measuring field

on the object plane

**MFOV** Recommended, smallest measuring object size of 3 x 3 pixels or 2 x 2 pixels when using the

PI microscope optics or the Xi 80, respectively



### **Optris Calculator**

Combines the measuring spot size calculator of the IR pyrometers and the optics calculator of the IR cameras

#### **Pyrometers**

- The spot size calculator determines the exact spot size for all sensor / optics combinations for any entered distance
- · For reliable measurements

### **Features**

 Calculates for each distance the measuring spot size of the respective device



The measuring spot size of the respective device is calculated for each distance



#### IR cameras

- Based on camera / lens combination and the distance to the object, the measuring field dimensions and pixel size are calculated precisely.
- Ensures an optimal positioning of the camera and the avoidance of measuring errors

#### Supported for

 All android devices (5.0 or higher)



# **Optical data**

# OPTICS

PI 640i / PI 640i G7	gth	ment					Dis	tance 1	to mea	sureme	nt obje	ect [m]				
640 x 480 px	Focal length [mm]	Minimum measurement distance*	Angle		0.05	0.1	0.2	0.3	0.5	1	2	4	6	10	30	100
O33 Standard lens	19	0.3 m	33° 25° 42° 0.9 mrad	HFOV [m] VFOV [m] DFOV [m] IFOV [mm]		0.064 0.047 0.079 0.1	0.12 0.09 0.15 0.2	0.18 0.14 0.23 0.3	0.30 0.23 0.38 0.5	0.60 0.45 0.75 0.9	1.20 0.9 1.5 1.9	2.4 1.8 3.0 3.7	3.6 2.7 4.5 5.6	6.0 4.5 7.5 9.3	17.9 13.4 22.4 28.0	59.7 44.5 74.5 93.3
O15 Telephoto lens	42	0.5 m	15° 11° 19° 0.4 mrad	HFOV [m] VFOV [m] DFOV [m] IFOV [mm]					0.14 0.10 0.17 0.2	0.27 0.20 0.33 0.4	0.53 0.40 0.66 0.8	1.0 0.8 1.3 1.6	1.6 1.2 2.0 2.4	2.6 2.0 3.3 4.1	7.8 5.9 9.8 12.3	26.2 19.6 32.7 40.9
O60 Wide angle lens	11	0.2 m	60° 45° 75° 1.9 mrad	HFOV [m] VFOV [m] DFOV [m] IFOV [mm]	0.07 0.05 0.09 0.1	0.13 0.09 0.16 0.2	0.24 0.17 0.30 0.4	0.35 0.26 0.44 0.6	0.60 0.42 0.73 0.9	1.2 0.8 1.4 1.8	2.3 1.7 2.9 3.7	4.7 3.3 5.7 7.3	7.0 5.0 8.6 10.9	11.7 8.3 14.3 18.2	34.9 24.9 42.9 54.6	116.4 82.9 142.9 182
O90 Super wide angle lens	8	0.2 m	90° 64° 110° 3.2 mrad	HFOV [m] VFOV [m] DFOV [m] IFOV [mm]	0.11 0.07 0.14 0.2	0.22 0.14 0.26 0.3	0.42 0.26 0.49 0.7	0.62 0.39 0.73 1.0	1.0 0.6 1.2 1.6	2.0 1.3 2.4 3.2	4.0 2.5 4.8 6.3	8.1 5.0 9.5 12.6	12.1 7.6 14.2 18.9	20.2 12.6 23.8 31.5	60.4 37.7 71.3 94.4	201.4 125.7 237.4 315

Microscope optics PI 640i	length	ا ment *		Distance to measurement object [m]						
640 x 480 px	Focal ler [mm]	Minimum measurem distance*	Angle		0.08	0.09	0.1			
MO44	44.2	0.08 m	12°	HFOV [m]	0.018	0.021	0.023			
Microscope optics			9°	VFOV [m]	0.014	0.016	0.017			
			15°	DFOV [m]	0.023	0.026	0.029			
			0.36 mrad	IFOV [mm]	0.028	0.032	0.036			

Microscope optics Xi 400	£	nent		Distance to measurement object [m]						
382 x 288 px	Focal length [mm]	Minimum measurem distance*	Angle		0.09	0.1	0.11			
F20 CF	20 0.09 m	0.09 m	18°	HFOV [m]	0.031	0.034	0.037			
Microscope optics			14°	VFOV [m]	0.024	0.026	0.028			
			23°	DFOV [m]	0.039	0.043	0.047			
			0.9 mrad	IFOV [mm]	0.08	0.09	0.10			

PI 1M / <sub>1)</sub> PI 08M <sub>11</sub> / PI 08M <sub>11</sub> /				Distance to measurement object [m]											
PI 05M 764 x 480 px	Focal length [mm]	Minimum measurement distance*	Angle		0.1	0.2	0.3	0.5	1	2	4	6	10	30	100
OF16 Wide angle lens	16	0.2 m	39° 25° 46° 0.94 mrad	HFOV [m] VFOV [m] DFOV [m] IFOV [mm]		0.14 0.09 0.17 0.2	0.21 0.14 0.25 0.3	0.36 0.23 0.42 0.5	0.72 0.45 0.85 0.9	1.43 0.90 1.69 1.9	2.87 1.80 3.38 3.8	4.30 2.70 5.08 5.6	7.2 4.5 8.5 9.4	21.5 13.5 25.4 28.1	71.6 45.0 84.6 93.8
OF25 Standard lens	25	0.5 m	26° 16° 30° 0.60 mrad	HFOV [m] VFOV [m] DFOV [m] IFOV [mm]	0.046 0.029 0.054 0.1	0.09 0.06 0.11 0.1	0.14 0.09 0.16 0.2	0.23 0.14 0.27 0.3	0.46 0.29 0.54 0.6	0.92 0.58 1.08 1.2	1.83 1.15 2.17 2.4	2.75 1.73 3.25 3.6	4.6 2.9 5.4 6.0	13.8 8.6 16.2 18.0	45.8 28.8 54.1 60.0
OF50 Telephoto lens	50	1.5 m	13° 8° 15° 0.30 mrad	HFOV [m] VFOV [m] DFOV [m] IFOV [mm]				0.11 0.07 0.14 0.2	0.23 0.14 0.27 0.3	0.46 0.29 0.54 0.6	0.92 0.58 1.08 1.2	1.38 0.86 1.62 1.8	2.3 1.4 2.7 3.0	6.9 4.3 8.1 9.0	22.9 14.4 27.1 30.0
OF75 Telephoto lens	75	2.0 m	9° 5° 10° 0.20 mrad	HFOV [m] VFOV [m] DFOV [m] IFOV [mm]					0.15 0.10 0.18 0.2	0.31 0.19 0.36 0.4	0.61 0.38 0.72 0.8	0.92 0.58 1.08 1.2	1.5 1.0 1.8 2.0	4.6 2.9 5.4 6.0	15.3 9.6 18.0 20.0

<sup>&</sup>lt;sup>1)</sup>The optris PI 05M is only available with OF25 lens and the optris PI 08M is available with OF16 and OF25 lens.

PI 1M / <sub>1)</sub> PI 08M <sub>1)</sub> /	gth	nent		Distance to measurement object [m]											
<b>PI 05M</b> <sup>1)</sup> 382 x 288 px	Focal length [mm]	Minimum measurement distance*	Angle		0.1	0.2	0.3	0.5	1	2	4	6	10	30	100
OF16 Wide angle lens	16	0.2 m	20° 15° 25° 0.94 mrad	HFOV [m] VFOV [m] DFOV [m] IFOV [mm]		0.07 0.05 0.09 0.2	0.11 0.08 0.13 0.3	0.18 0.14 0.22 0.5	0.36 0.27 0.45 0.9	0.72 0.54 0.90 1.9	1.43 1.08 1.79 3.8	2.15 1.62 2.69 5.6	3.6 2.7 4.5 9.4	10.7 8.1 13.5 28.1	35.8 27.0 44.9 93.8
OF25 Standard lens	25	0.5 m	13° 10° 16° 0.60 mrad	HFOV [m] VFOV [m] DFOV [m] IFOV [mm]	0.023 0.017 0.029 0.1	0.05 0.03 0.06 0.1	0.07 0.05 0.09 0.2	0.11 0.09 0.14 0.3	0.23 0.17 0.29 0.6	0.46 0.35 0.57 1.2	0.92 0.69 1.15 2.4	1.38 1.04 1.72 3.6	2.3 1.7 2.9 6.0	6.9 5.2 8.6 18.0	22.9 17.3 28.7 60.0
OF50 Telephoto lens	50	1.5 m	7° 5° 8° 0.30 mrad	HFOV [m] VFOV [m] DFOV [m] IFOV [mm]				0.06 0.04 0.07 0.2	0.11 0.09 0.14 0.3	0.23 0.17 0.29 0.6	0.46 0.35 0.57 1.2	0.69 0.52 0.86 1.8	1.1 0.9 1.4 3.0	3.4 2.6 4.3 9.0	11.5 8.6 14.4 30.0
OF75 Telephoto lens	75	2.0 m	4° 3° 5° 0.20 mrad	HFOV [m] VFOV [m] DFOV [m] IFOV [mm]					0.08 0.06 0.10 0.2	0.15 0.12 0.19 0.4	0.31 0.23 0.38 0.8	0.46 0.35 0.57 1.2	0.8 0.6 1.0 2.0	2.3 1.7 2.9 6.0	7.6 5.8 9.6 20.0

Table with examples showing which measurement field sizes and pixel sizes will be reached at which distance. For optimal configuration of the camera there are various lenses available. Wide angle lenses have radial distortion due to the angle of their aperture. The PIX Connect software has an algorithm which corrects this distortion.

The measurement accuracy of the camera may lie outside of the specifications for distances below the defined minimum measurement distance.

<sup>\*</sup>Please note: Please use the optics calculator on our website in order to calculate measurement fields with shorter measurement distances:

<sup>&</sup>lt;sup>1)</sup>The optris PI 05M is only available with OF25 lens and the optris PI 08M is available with OF16 and OF25 lens.